

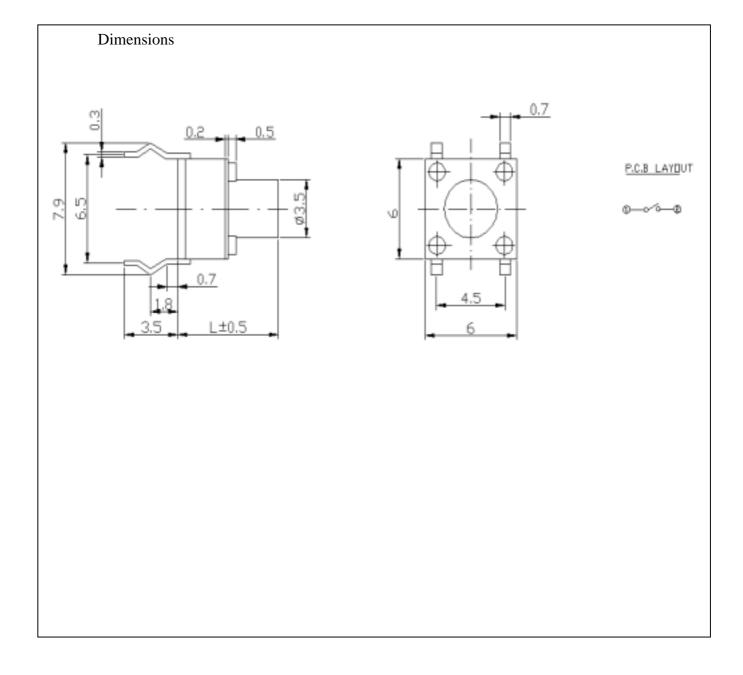
Tact Switch Series (6x6mm)

TS6601H



Part Number

Model No.	High (L)	Model No.	High (L)
TS6601H	4.3	TS6601HE	7.3
TS6601HA	5.0	TS6601HF	12.5
TS6601HB	7.0	TS6601HG	13.5
TS6601HC	8.0	TS6601HK	4.7
TS6601HD	9.5		





Tact Switch Series (6x6mm)

	TACTING	SWITCH	SPECIFI	CATION		
1. GENERAL						
1.1 Scope	This specification co	vers the require	ements for sin	ngle key switch	es which have no	
	keytop(TACT SWIT	CHES: MECI	HANICAL C	ONTACT).		
1.2 Operating	Temperature Range					
	-20 to 70°C (normal	humidity, norn	nal press.)			
1.3 Storage Te	mperature Range					
	-30 to 80°C (normal	humidity, norn	nal press.)			
1.4 Test Condi	tions					
	Tests and measureme	ents shall be ma	ade in the fol	lowing standard	d conditions unles	S
	otherwise specified:					
	Normal temperatur	· -				
	Normal humidity (•	•	•		
	Normal pressure ()	-				
	In case any question		judgement n	nade, tests shall	be conducted in	the
	following conditions					
	Temperature	(20±2°C	,			
	Relative humidity		,			
	Pressure	•	1060 m bars	i)		
	ICE, STYLE, AND D	IMENSIONS				
2.1 Appearance			1.11. 6.1			
	l be no defects that affe	ect the servicea	bility of the p	product.		
2.2 Style and I		1 1.1 1.	.			
	Shall conform to the	ne assembly dr	awings.			
3. TYPE OF A	CIUATION	Tastila f	a adha alz			
4 CONTACT A	RRANGEMENT		eedback throws			
4. CONTACT A	-	1 poles		are given in the	assembly drawin	ine)
5. MAXIMUM 1		C 12 V	•	•	assembly drawing	.gs.)
5. MAXIMOM	KATINGS D	C <u>12</u> V		ι		
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TACTING SWITCH SPECIFICATION

6. PERFORMANCE

6.1 Electrical

Item	Test Conditions	Requirements
6.1.1. Contact Resistance	Applying a static load twice the actuating force to the center of the stem, measurements shall be made with a 1 kHz small-current contact resistance meter.	_100_ m ohm max.
6.1.2. Insulation Resistance	Measurements shall be made following application of DC <u>250</u> V potential across terminals and across terminals and frame for one minute.	_100_ M ohm min.
6.1.3. Dielectric withstanding voltage	AC 500 V (50Hz or 60Hz) shall be applied across terminals and across terminals and frame for one minute.	There shall be no breakdown.
6.1.4. Bounce	Lightly striking the center of the stem at a rate encountered in normal use (3 to 4 operations per sec.), bounce shall be tested at "ON" and "OFF".	5 m sec max.

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6.2 Mechanical

Item	Test Conditions	Requirements
6.2.1. Actuating Force	Placing the switch such that the direction of switch operation is vertical and then gradually increasing the load applied to the center of the stem, the maximum load required for the stem to come to a stop shall be measured.	160 ± 50 g f OR 250 ± 50 g f
6.2.2. Travel	Placing the switch such that the direction of switch operation is vertical and then applying a static load twice the actuating force to the center of the stem, the travel distance for the stem to come to a stop shall be measured.	<u>0.3</u> ± <u>0.15</u> m m
6.2.3. Return Force	The sample switch is installed such that the direction of switch operation is vertical and, upon depression of the stem in its center the whole travel distance, the force of the stem to return to its free position shall be measured.	50 g f min.
6.2.4. Stop Strength	Placing the switch such that the direction of switch operation is vertical, a static load of 3 kgf shall be applied in the direction of stem operation for a period of 60 seconds.	There shall be no sign of damage mechanically and electrically.
6.2.5 Stem Strength	Placing the switch such that the direction of switch operation is vertical, the maximum force to withstand a pull applied opposite to the direction of stem operation shall be measured.	3 k g f

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Resistance for one hour before measurements are made: (1) Temperature: 60±2°C (2)Relative humidity: 90 to 95% (3) Time: 96 hours (4)Water drops shall be removed. Following five cycles of the temperature cycling test set forth below the sample shall be left in normal temperature and humidity conditions for one hour before measurements are made. During this test, water drops shall be removed. Insulation resistance 10 M ohm min of the first of the fi	Item	Test Conditions	Requirements
Left in normal temperature and humidity conditions Item 6.1	Resistance to Low	left in normal temperature and humidity conditions for one hour before measurements are made: (1)Temperature: -30±2°C (2) Time: 96 hours	Item 6.2.1
Moisture Resistance left in normal temperature and humidity conditions for one hour before measurements are made: (1) Temperature: 60±2°C (2)Relative humidity: 90 to 95% (3) Time: 96 hours (4)Water drops shall be removed. Temperature Following five cycles of the temperature cycling test set forth below the sample shall be left in normal Cycling Following this test, water drops shall be removed. 1 cycle 10 M ohm mix Item 6.1.3 Item 6.2.1	Heat	left in normal temperature and humidity conditions for one hour before measurements are made: (1)Temperature: 80±2°C	Item 6.2.1
Temperature set forth below the sample shall be left in normal temperature and humidity conditions for one hour before measurements are made. During this test, water drops shall be removed.	Moisture	left in normal temperature and humidity conditions for one hour before measurements are made: (1) Temperature: 60±2°C (2)Relative humidity: 90 to 95% (3) Time: 96 hours	200 m ohm max. Insulation resistance 10 M ohm min Item 6.1.3 Item 6.1.4 Item 6.2.1
I 2H IH 2H IH I	Temperature	set forth below the sample shall be left in normal temperature and humidity conditions for one hour before measurements are made. During this test, water drops shall be removed. 1 cycle +60	Item 6.1 Item 6.2.1

6.4.1. Operating Life 6.4.2. Vibration Resistance	Measurements shall be made following the test set forth below: (1)DC 5V 5mA resistive load (2)Rate of operation: 2 to 3 operations per second (3)Depression: 300 g f (4)Cycles of operation: 10 x 10 ⁴ cycles Measurements shall be made following the test set forth below: (1)Range of oscillation: 10 to 55 Hz (2)Amplitude, pk-to-pk:1.5 mm (3)Cycle of sweep: 10 -55 -10 Hz in one minute, approx.	Contact resistance:
6.4.2. Vibration	(1)DC 5V 5mA resistive load (2)Rate of operation: 2 to 3 operations per second (3)Depression: 300 g f (4)Cycles of operation: 10 x 10 ⁴ cycles Measurements shall be made following the test set forth below: (1)Range of oscillation: 10 to 55 Hz (2)Amplitude, pk-to-pk:1.5 mm (3)Cycle of sweep: 10 -55 -10 Hz in one minute,	Insulation resistance:
Vibration	(2)Rate of operation: 2 to 3 operations per second (3)Depression: 300 g f (4)Cycles of operation: 10 x 10 ⁴ cycles Measurements shall be made following the test set forth below: (1)Range of oscillation: 10 to 55 Hz (2)Amplitude, pk-to-pk:1.5 mm (3)Cycle of sweep: 10 -55 -10 Hz in one minute,	
Vibration	(3)Depression: 300 g f (4)Cycles of operation: 10 x 10 ⁴ cycles Measurements shall be made following the test set forth below: (1)Range of oscillation: 10 to 55 Hz (2)Amplitude, pk-to-pk:1.5 mm (3)Cycle of sweep: 10 -55 -10 Hz in one minute,	Bounce: 10 m sec max. Actuating force: + 30 % or - 30 % of initial force Item 6.1.3 Item 6.2.2 Item 6.1 Item 6.2.1
Vibration	(4)Cycles of operation: 10 x 10 ⁴ cycles Measurements shall be made following the test set forth below: (1)Range of oscillation: 10 to 55 Hz (2)Amplitude, pk-to-pk:1.5 mm (3)Cycle of sweep: 10 -55 -10 Hz in one minute,	max. Actuating force: + 30 % or - 30 % of initial force Item 6.1.3 Item 6.2.2 Item 6.1 Item 6.2.1
Vibration	Measurements shall be made following the test set forth below: (1)Range of oscillation: 10 to 55 Hz (2)Amplitude, pk-to-pk:1.5 mm (3)Cycle of sweep: 10 -55 -10 Hz in one minute,	Actuating force: + 30 % or - 30 % of initial force Item 6.1.3 Item 6.2.2 Item 6.1 Item 6.2.1
Vibration	Measurements shall be made following the test set forth below: (1)Range of oscillation: 10 to 55 Hz (2)Amplitude, pk-to-pk:1.5 mm (3)Cycle of sweep: 10 -55 -10 Hz in one minute,	+ 30 % or - 30 % of initial force Item 6.1.3 Item 6.2.2 Item 6.1 Item 6.2.1
Vibration	forth below: (1)Range of oscillation: 10 to 55 Hz (2)Amplitude, pk-to-pk:1.5 mm (3)Cycle of sweep: 10 -55 -10 Hz in one minute,	- 30 % of initial force Item 6.1.3 Item 6.2.2 Item 6.1 Item 6.2.1
Vibration	forth below: (1)Range of oscillation: 10 to 55 Hz (2)Amplitude, pk-to-pk:1.5 mm (3)Cycle of sweep: 10 -55 -10 Hz in one minute,	force Item 6.1.3 Item 6.2.2 Item 6.1 Item 6.2.1
Vibration	forth below: (1)Range of oscillation: 10 to 55 Hz (2)Amplitude, pk-to-pk:1.5 mm (3)Cycle of sweep: 10 -55 -10 Hz in one minute,	Item 6.2.2 Item 6.1 Item 6.2.1
Vibration	forth below: (1)Range of oscillation: 10 to 55 Hz (2)Amplitude, pk-to-pk:1.5 mm (3)Cycle of sweep: 10 -55 -10 Hz in one minute,	Item 6.1 Item 6.2.1
Vibration	forth below: (1)Range of oscillation: 10 to 55 Hz (2)Amplitude, pk-to-pk:1.5 mm (3)Cycle of sweep: 10 -55 -10 Hz in one minute,	Item 6.2.1
	(1)Range of oscillation: 10 to 55 Hz (2)Amplitude, pk-to-pk:1.5 mm (3)Cycle of sweep: 10 -55 -10 Hz in one minute,	
Resistance	(2)Amplitude, pk-to-pk:1.5 mm (3)Cycle of sweep: 10 -55 -10 Hz in one minute,	Item 6.2.2
	(3)Cycle of sweep: 10 -55 -10 Hz in one minute,	
	•	
	approx	
	appron.	
	(4)Mode of sweep: Logarithmically sweep or	
	uniform sweep	
	(5)Direction of oscillation:	
	Three mutually perpendicular directions,	
	including the direction of stem travel	
	(6)Duration of testing:	
	2 hours each, for a total of 6 hours	
6.4.3.	Measurements shall be made following the test set	Item 6.1
Impact Shock	forth below:	Item 6.2.1
Resistance	(1)Acceleration:80g	Item 6.2.2
	(2)Cycles of test:3 cycles each in 6 directions, for a	
	total of 18 cycles	
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7. Switch Handling Precautions

7.1 In case an automatic flow soldering apparatus is used for soldering, adhere to the following conditions:

Item	Soldering condition
7.1.1. Preheat Temperature	100 max (Ambient temperature of printed circuit board on its soldering side)
7.1.2. Preheat Time	45 sec max.
7.1.3. Flux Foaming	To such an extent that fluxes will be kept flush with the printed circuit board's top surface on which components are mounted. Preparatory flux must not be applied to that side of printed circuit board on which components are mounted and to the area where terminals located.
7.1.4. Soldering Temperature	255 max.
7.1.5. Duration of Solder Immersion	5 sec. max.
7.1.6. Allowable Frequency of Soldering process	2 times max.

7.2 Other precautions

- **7.2.1.** Following the soldering process, do not try to clean the switch with a solvent or the like.
- **7.2.2.** Safeguard the switch assembly against flux penetration from its topside.
- **7.2.3.** Please have the products keep in close status and the storage time is 90 days guaranty after delivering the goods at most.

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